



The CLIC accelerating structure development program

MeChanICs Kick Off Meeting 6 September 2010 W. Wuensch





Outline

- Introduction
- Coupled rf design and linac optimization
- High-power test program
- Manufacturing
- Transverse wakefield suppression
- Fundamental breakdown and pulsed-surfaceheating studies

Introduction:

The main challenges for accelerating structures for CLIC:

100 MV/m accelerating gradient with a breakdown rate of the order of 10⁻⁷/pulse/m, pulse length of 250 ns. Performance is mainly limited by vacuum breakdown and pulsed surface heating. Need strong coupling to the beam to remain efficient which in turn gives,

Demanding beam dynamics requirements - low short-range transverse wakefields and strong long-range wakefield suppression. Both complicate getting a high gradient. Requires micron assembly and alignment tolerances.

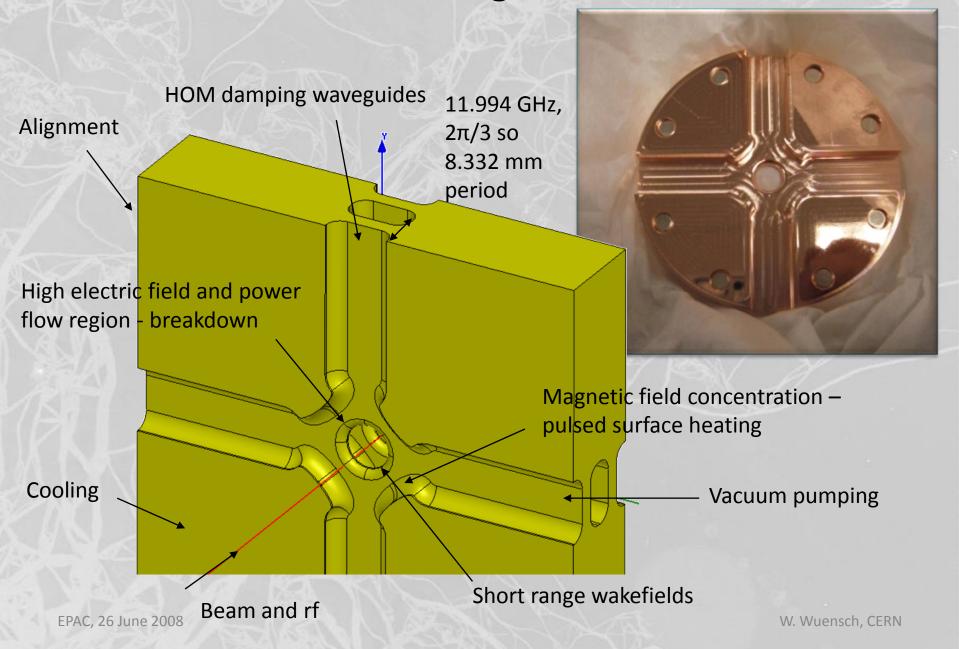
I will not cover our PETS, decelerating structure, program today.



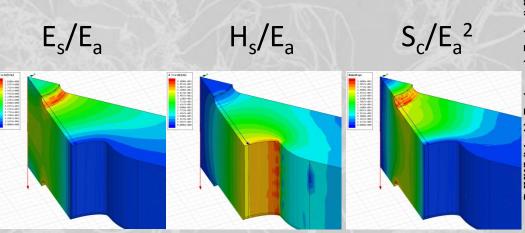


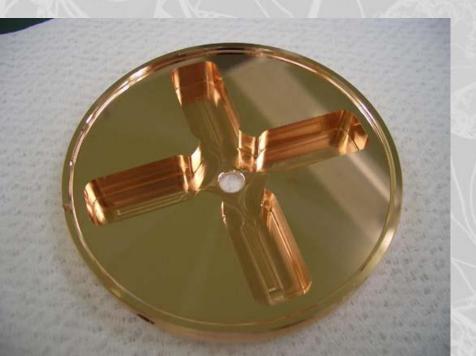
Coupled rf design and linac optimization

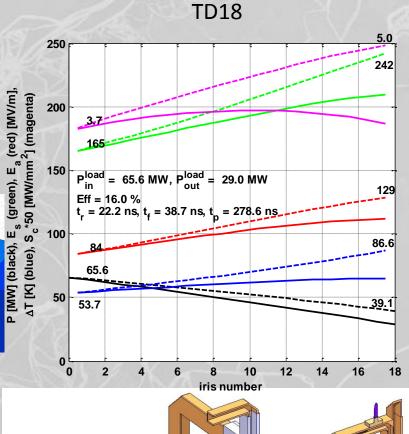
Baseline accelerating structure features

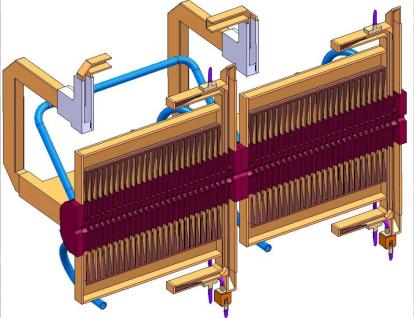


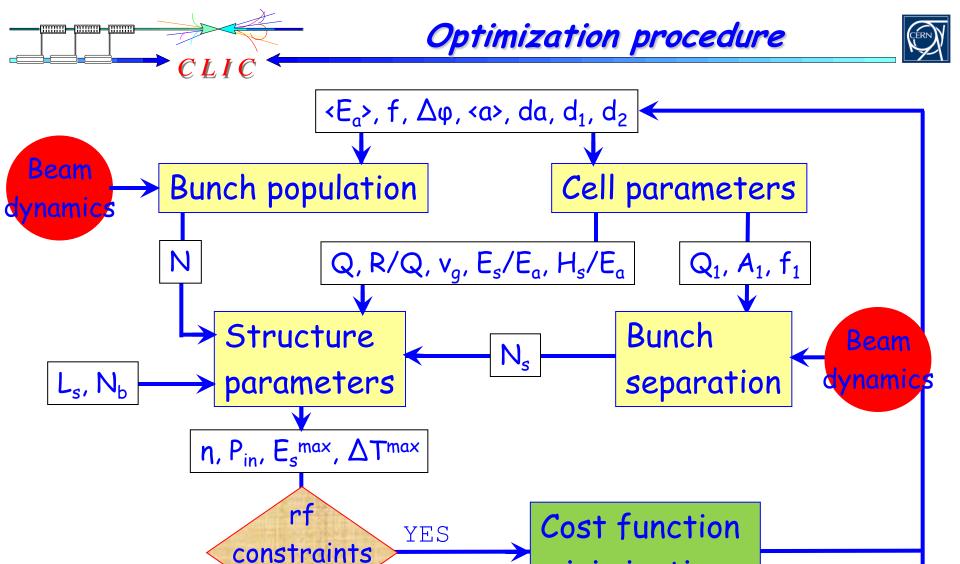
Accelerating structure features





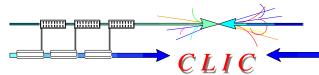






NO

minimization



Beam dynamics input





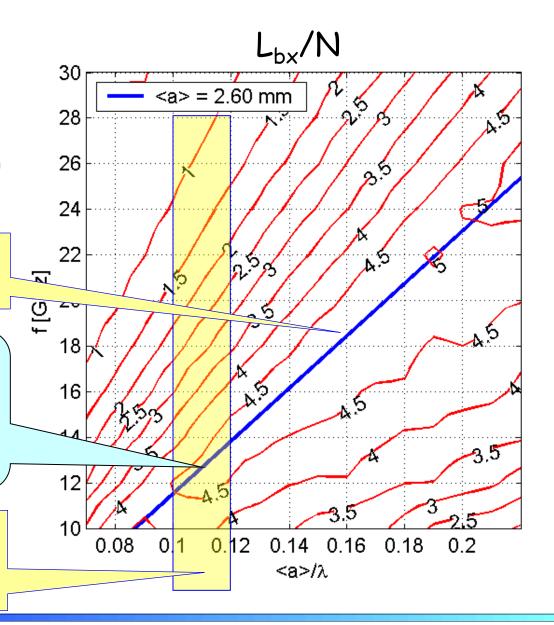
BD



BD optimum aperture: <a> = 2.6 mm

Why X-band?
Crossing gives
optimum frequency

High-power RF optimum aperture: $\langle \alpha \rangle / \lambda = 0.1 \div 0.12$





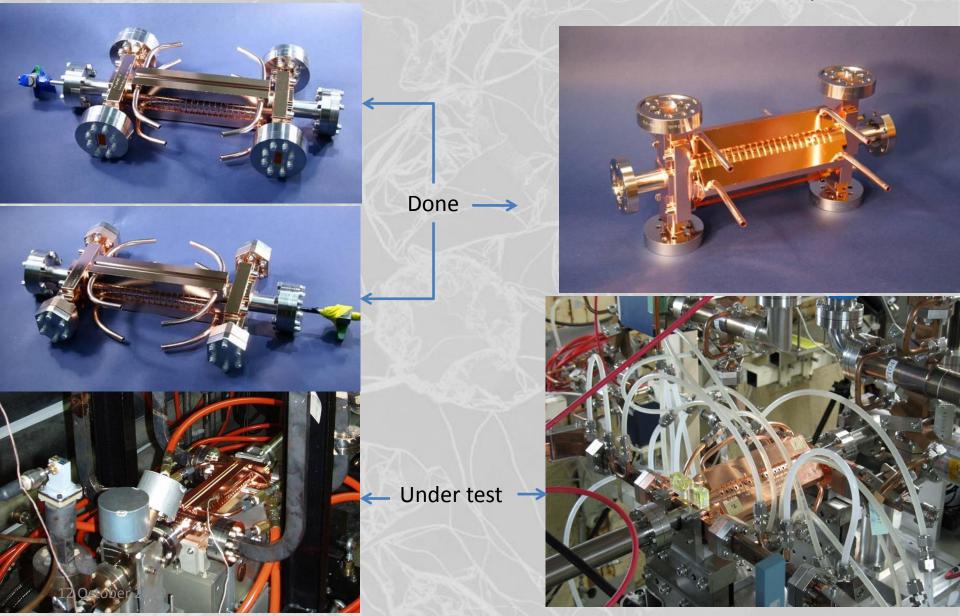


High-power test program

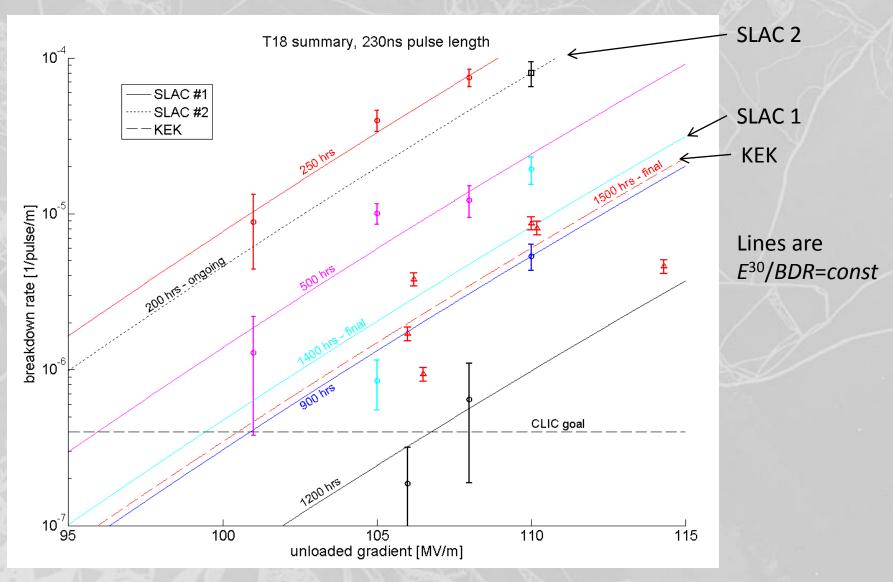
CERN/KEK/SLAC high-power test structures

T18 - undamped

TD18 - damped



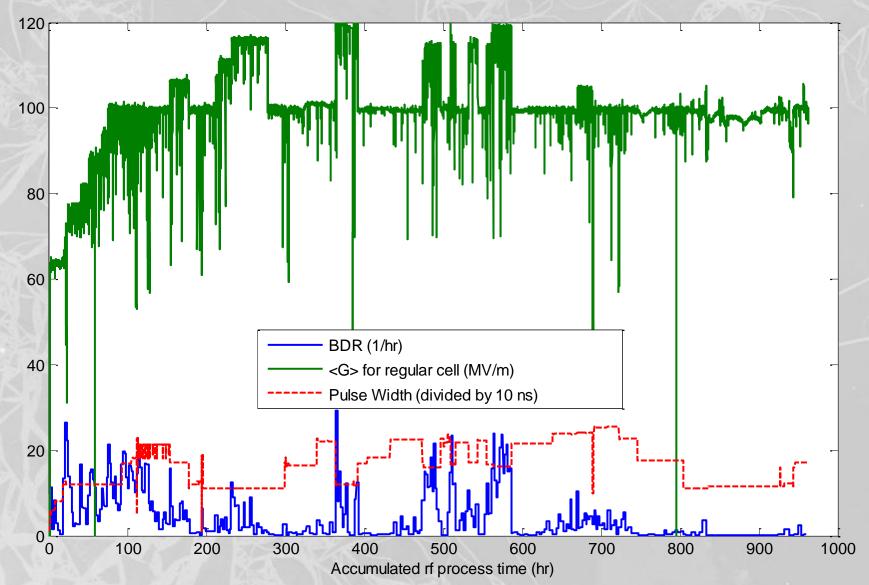
CERN/KEK/SLAC T18 structure tests



12 October 2009

W. Wuensch

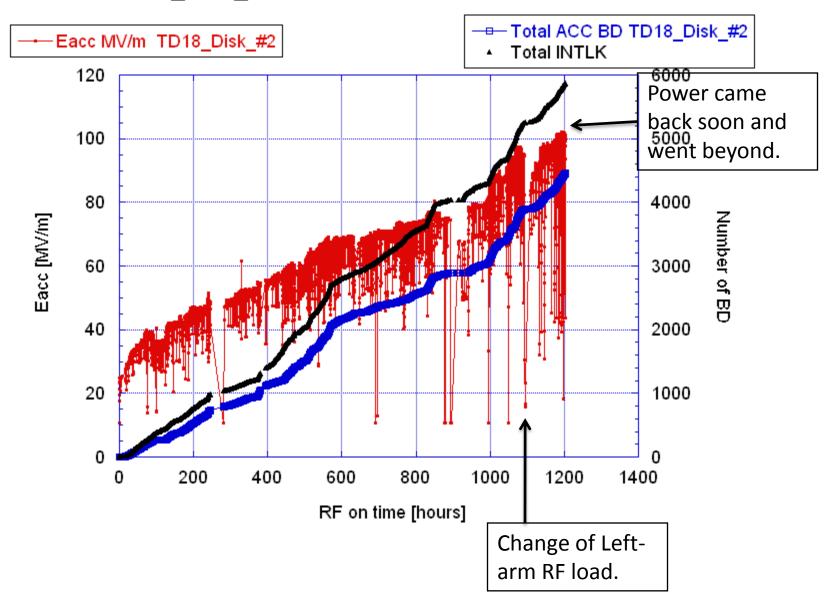
High Power Test begin at 12/03/2009 15:00



TD-18

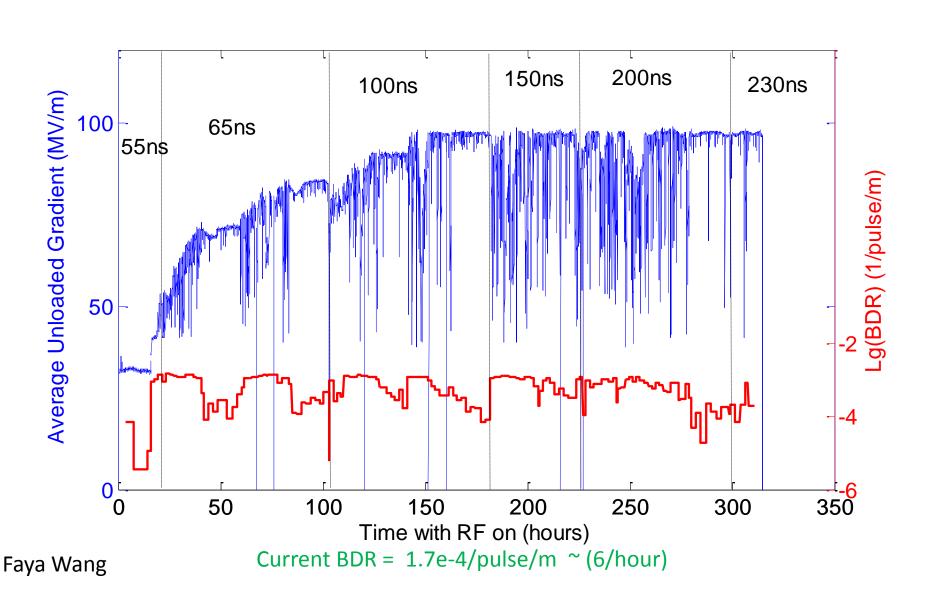
Faya Wang, SLAC

TD18_Disk_#2 Eacc and # of breakdowns



RF Process Results T18_Disk_2 Made by CERN

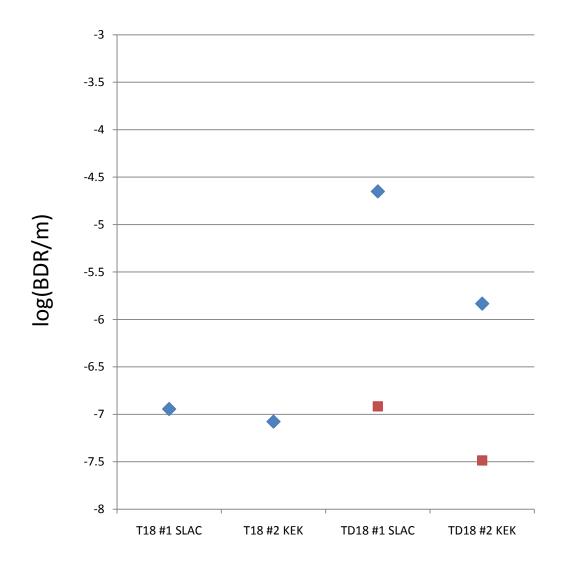
Started at Aug/02/2010 1e-3(1/pulse/m) = 34.6/hour at 60 Hz for 0.16 m



Summary of completed CLIC structure test results through June 2010 - measured data

Structure name	Unloaded gradient [MV/m]	Flat top pulse length [ns]	Breakdown rate [1/pulse/meter]
T18 #1 SLAC	105	230	1.6x10 ⁻⁶
T18 #2 KEK	102	252	8x10 ⁻⁷
TD18 #1 SLAC	85	230	2.4x10 ⁻⁶
	100	230	7.6x10 ⁻⁵
TD18 #2 KEK	87	252	2x10 ⁻⁶
	102	252	1.4x10 ⁻⁵

The effect of damping waveguides in T/TD18



All data scaled to a flat top pulse length of 180 ns using $E^6\tau$ =const

Blue points – 100 MV/m-range data scaled to 100 MV/m using E²⁹BDR=const

Red points – 85 MV/m-range data scaled to 80 MV/m using E²⁹BDR=const

Conclusion – Waveguides in T/TD18 cost a bit less than a factor 100 in BDR or alternatively 20% in gradient.

structure

Accelerating structure development core program

Adopt NLC/JLC technology

Structure for 100 MV/m using high-power scaling laws – T18

Two successful tests, third underway, have shown that 100 MV/m, 240 ns, 10⁻⁶ to 10⁻⁷ range is feasible.

Add damping features – TD18

Successful start of one test already shows damping features do not significantly affect performance. Damped structures at 100 MV/m are feasible.

Predicted equivalent performance from high-power limits but more efficient. Needs verification, tests in spring.

CLIC nominal structure with better rf design for higher efficiency – TD24 (and T24 to be systematic)

Mechanical design underway (tricky).

Verification of features such as SiC loads, compact coupler, wakefield monitor

Fine tuning of design, optimization of process, medium series production and testing

Accelerating structure critical issues and programs 2

Long range wakefield damping of the order of two orders of magnitude in six fundamental cycles.

- •Simulations using a number of different techniques and programs
- •Experimental program including a test in ASSET and indirect wakefield monitor tests.
- •Baseline heavy damping. Alternatives are slotted quadrants, DDS (Manchester) and Choke mode (Tsinghua)

Micron precision manufacture, assembly and integration

From CLIC advisory committee meeting of 2-2-2010

- Dedicated manufacturing study
- •Subsystem (cooling, vacuum, support) design
- Wakefield monitor development
- Dedicated cost studies are underway
- •Other X-band and high gradient applications like TERA, X-FEL to gain experience and spread expertise.

Dynamic Vacuum

• Work program is now being established. Goal is direct measurement, we will likely need a combination of measurement and simulation.

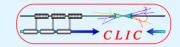




Manufacturing

CERN

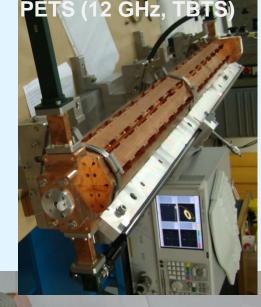
Introduction









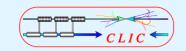








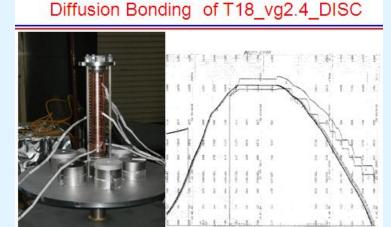
Baseline procedure



Diamond machining (sealed structures)



Cleaning with light etch



Pressure: 60 PSI (60 LB for this structure disks) Holding for 1 hour at 1020°C

J. Wuang

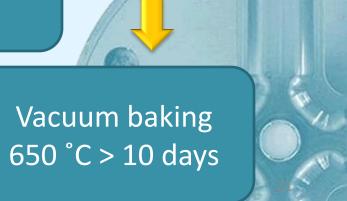
Vacuum Baking of T18_vg2.4_DISC



650° C 10 days

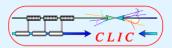
J. Wuang

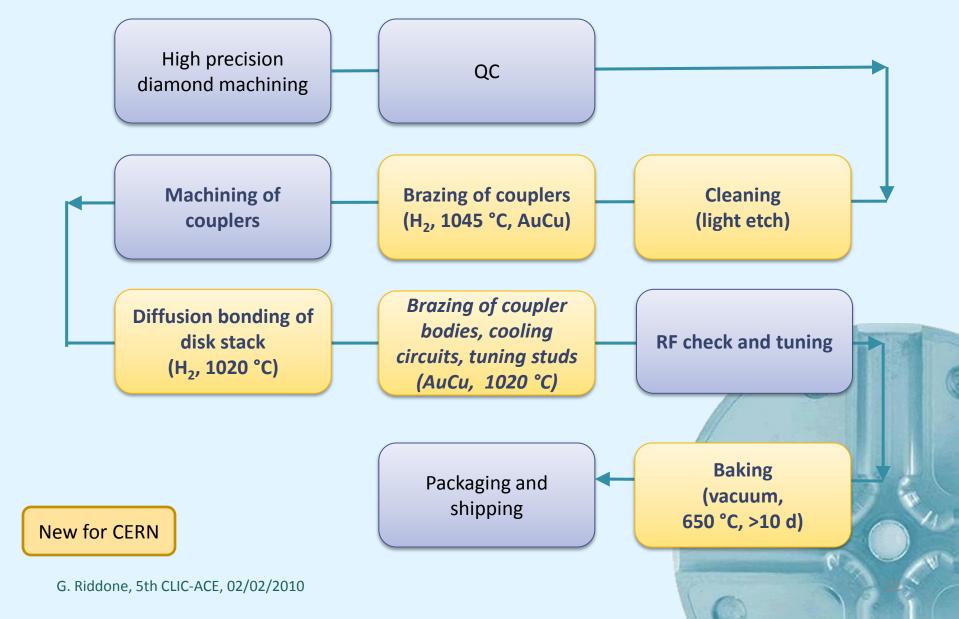
H2 diffusion bonding/brazing at ~ 1000 °C





Baseline manufacturing flow

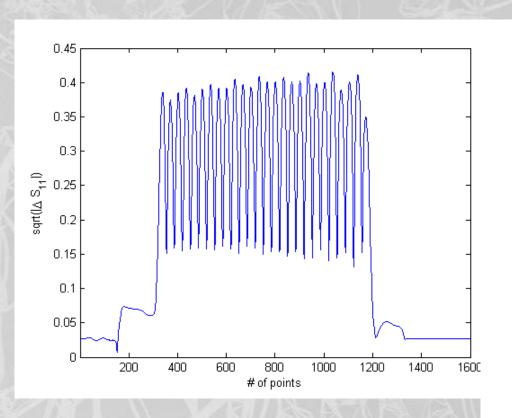


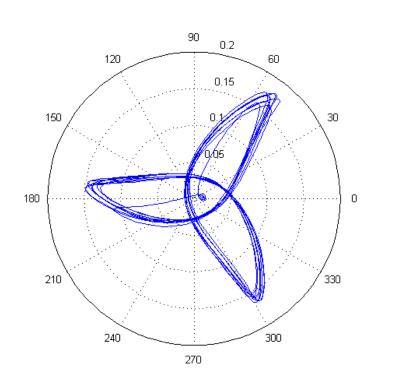






rf tuning TD24

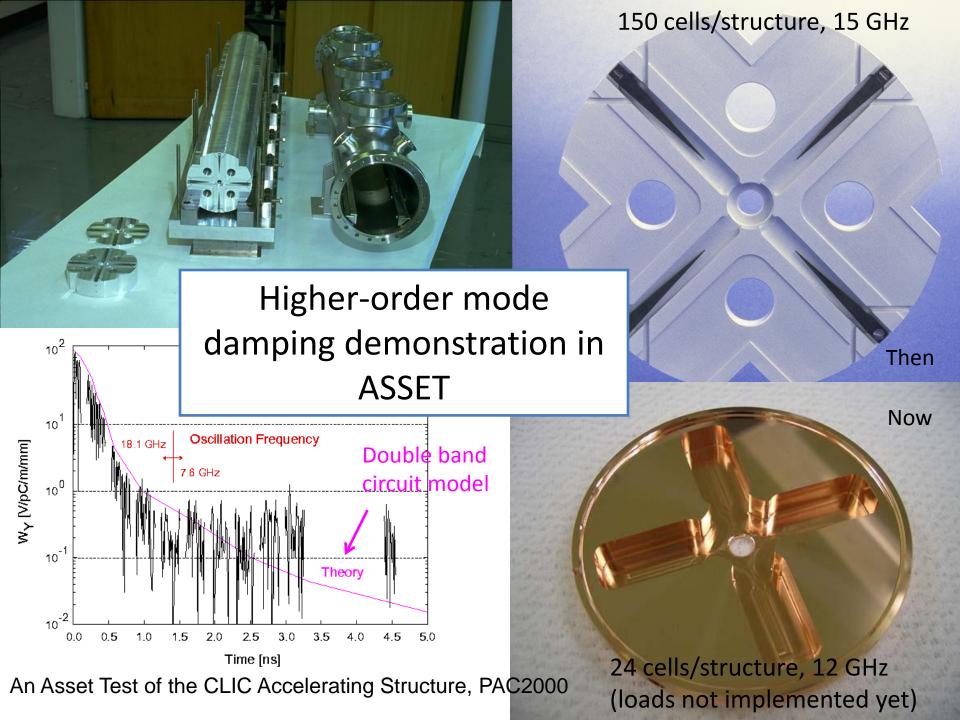


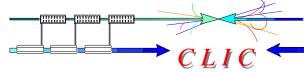






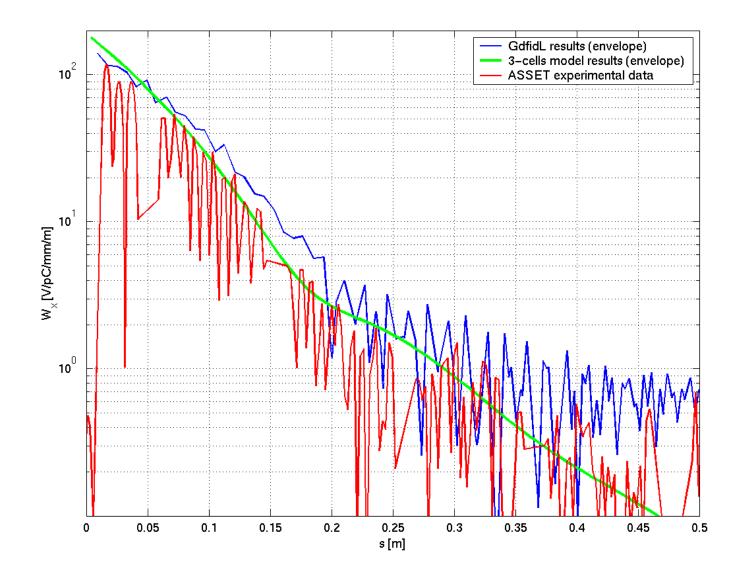
Transverse wakefield suppression



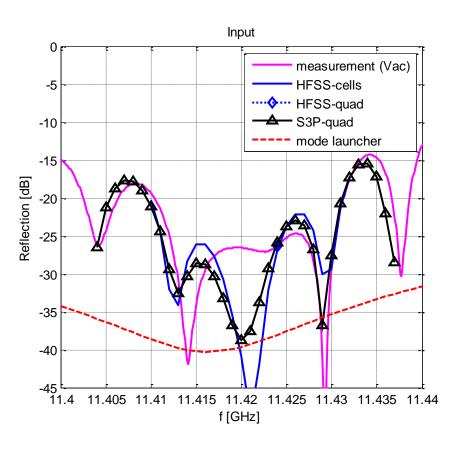


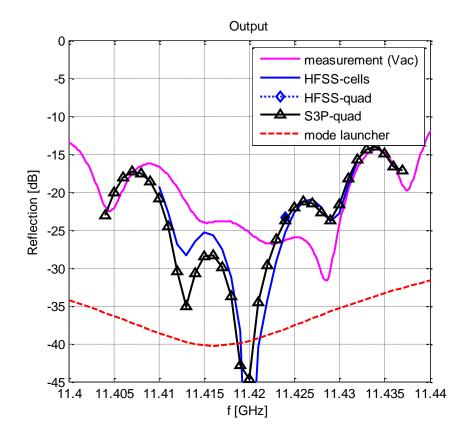
Full length TDS results comparison





Reflection: comparison





There is very small (~1MHz) or no difference in frequency between simulations and the air corrected measurements

Our computational capability is constantly being refined and benchmarked.

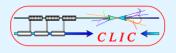




Fundamental breakdown and pulsed surface heating studies



High-power rf theory and simulation effort



Over the past couple of decades computational tools have developed to the point that we can now accurately design complex, 3-D and even multi-moded rf structures.

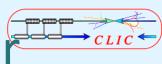
The ability to predict high-power performance has lagged behind:

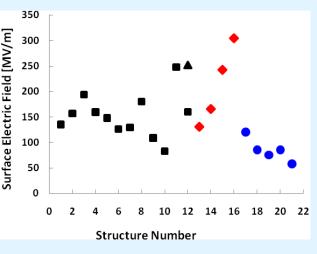
- A lot depends on preparation. But NLC/JLC made enormous progress in improving performance and reproducibility.
- The phenomena are extremely complex.

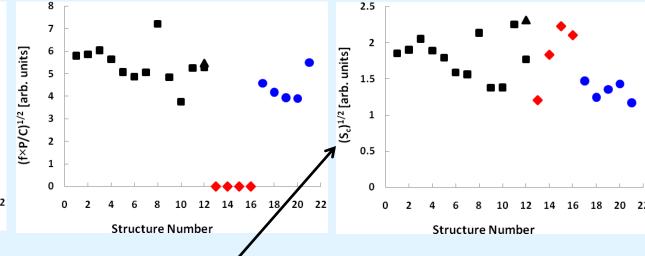
CLIC aims to run very close to the performance limit (for a given breakdown rate) so we had better understand the limit pretty well.



S_c: high-power design parameter

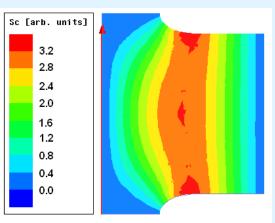






X-band and 30 GHz, pulses of the order of 100 ns.

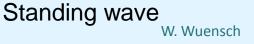
Travelling and standing wave

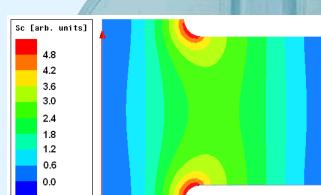


Related to the complex Poynting vector:

$$S_c = \Re\{\overline{S}\} + g_c \cdot \Im\{\overline{S}\}$$

Travelling wave







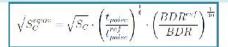
Do our high-gradient limits extend all the way down to S-band and microsecond pulses?
PRELIMINARY RESULTS!

TERA Foundation

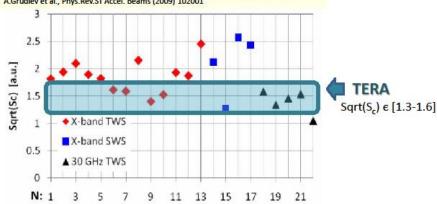
Validation of CLIC observations:

The modified Poynting vector as a RF constraint to high gradient performance

The square root of S_C has been scaled to t_{nulse} =200 ns and BDR=10⁻⁶ bbp/m



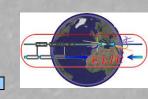
"A New Local Field Quantity Describing the High Gradient Limit of Accelerating Structures", A.Grudiev et al., Phys.Rev.ST Accel. Beams (2009) 102001



Silvia Verdú Andrés 18



Electrical Breakdown in multiscale modeling approach



5

M

0

N

SET



Stage 0: Onset of tip growth; Dislocation mechanism

Method: MD, Molecular Statics...

~ sec/min



~few fs



Stage 2: Atomic motion & evaporation *Method:* Hybrid ED&MD model

Classical MD+Electron Dynamics: Joule heating, screening effect

Solution of Laplace

Stage 3: Evolution of surface morphology due to the given charge distribution

Method: Kinetic Monte Carlo

~ sec/hours

=> Electron & ion & cluster emission ions

equation

Stage 4: Plasma evolution, burning of arc

Method: Particle-in-Cell (PIC)

~10s ns

=> Energy & flux of bombarding ions

Stage 5: Surface damage due to the intense ion bombardment from plasma *Metod:* Arc MD

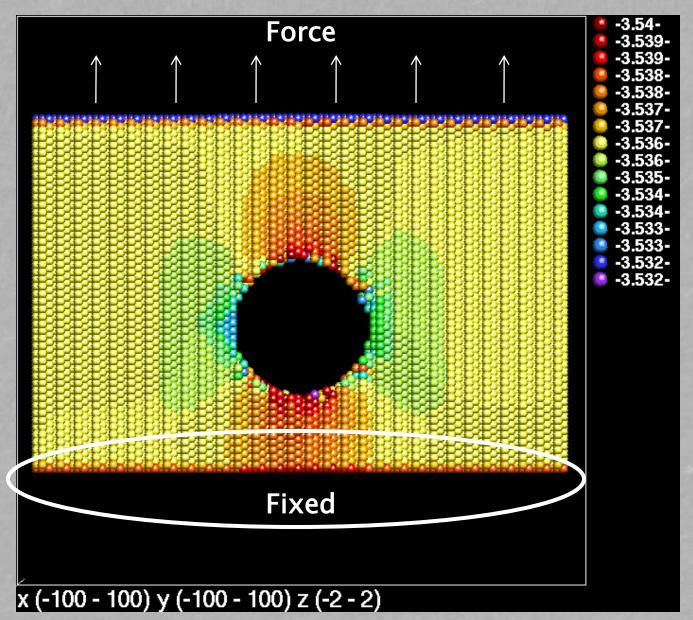
~100s ns





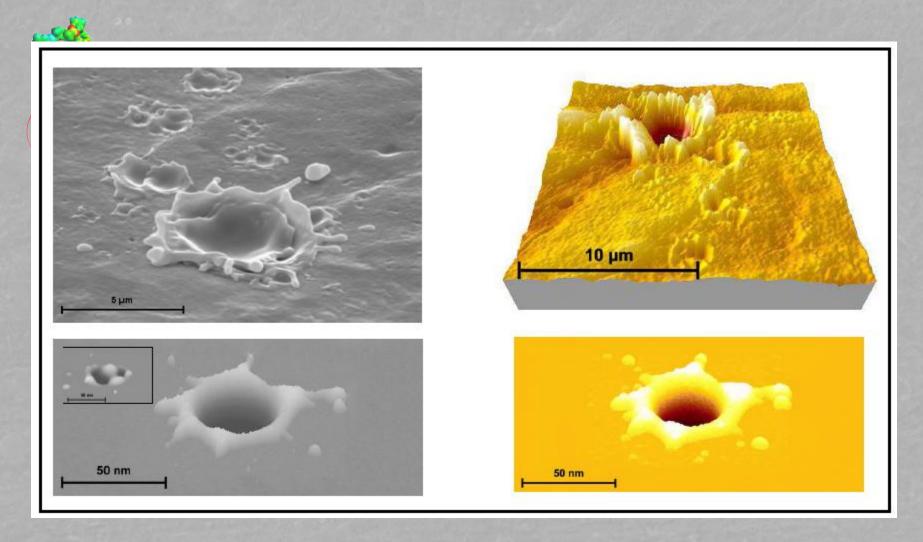


Voids as dislocation sources

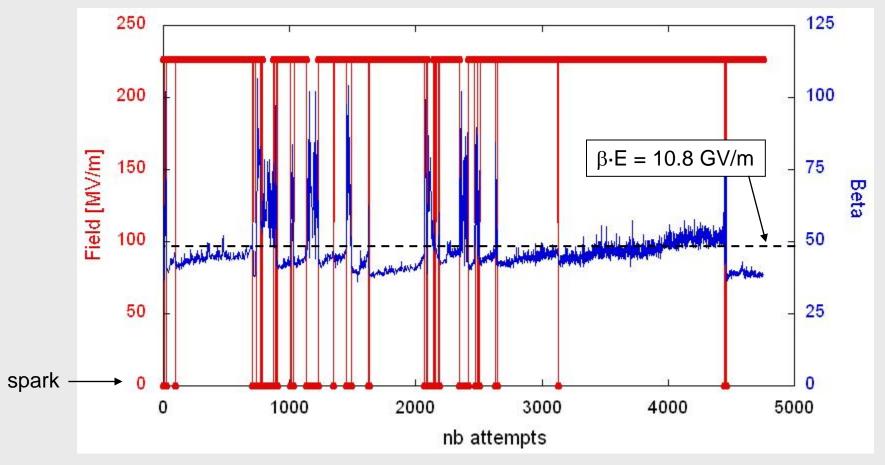




Plasma-surface interaction. Crater formation.



Evolution of β during BDR measurements (Cu)



- breakdown as soon as $\beta > 48$ ($\leftrightarrow \beta \cdot 225$ MV/m > 10.8 GV/m)
- consecutive breakdowns as long as $\beta > \beta_{\text{threshold}}$
- length and occurence of breakdown clusters \leftrightarrow evolution of β



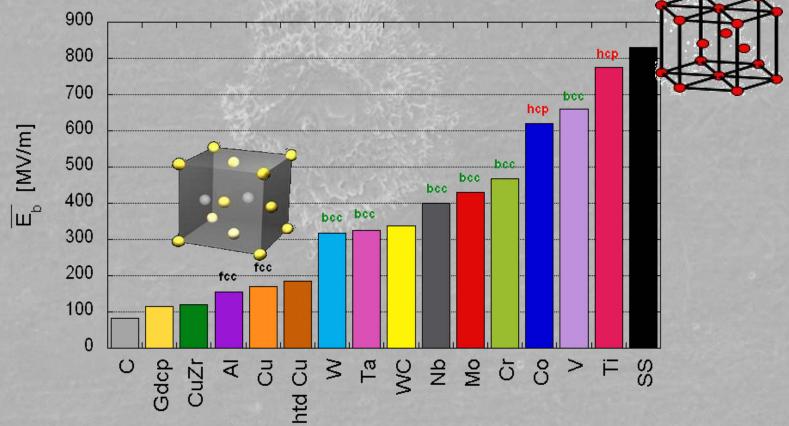


Recent experiment at CERN: CLIC-note

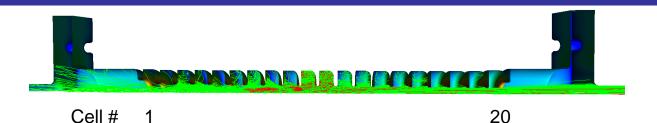


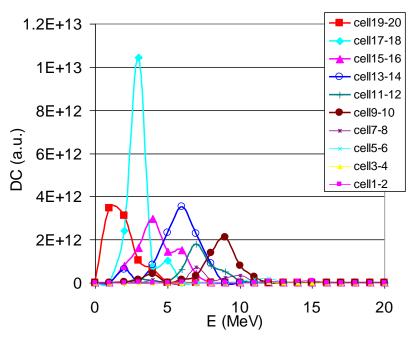


The dislocation motion is strongly bound to the atomic structure of metals. In FCC (face-centered cubic) the dislocation are the most mobile and HCP (hexagonal close-packed) are the hardest for dislocation mobility.



Energy of Captured Dark Current vs Location





Simulation

Electron energy as function of emission location.

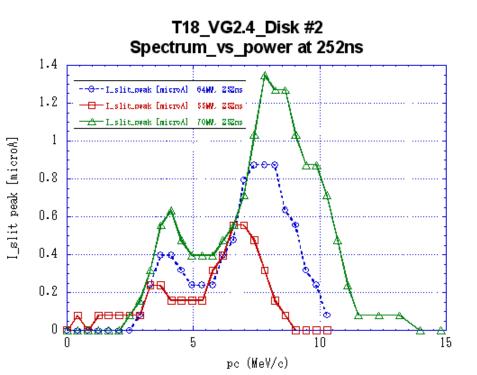
- Eacc=97MV/m.
- Higher cell number indicates downstream location

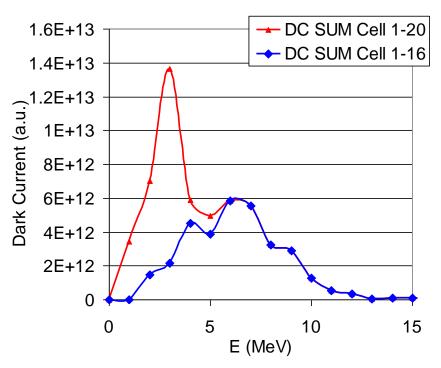
Electrons emitted upstream are accelerated to higher energy (monitored at output end).





Dark Current Spectrum Comparison





Measured dark current energy spectrum at downstream (need to scale by 1/(pc)

Spectrum from Track3P simulation, 97MV/m gradient.

"Certain" collimation of beampipe on dark current is considered in simulation data. More detailed analysis Needed.

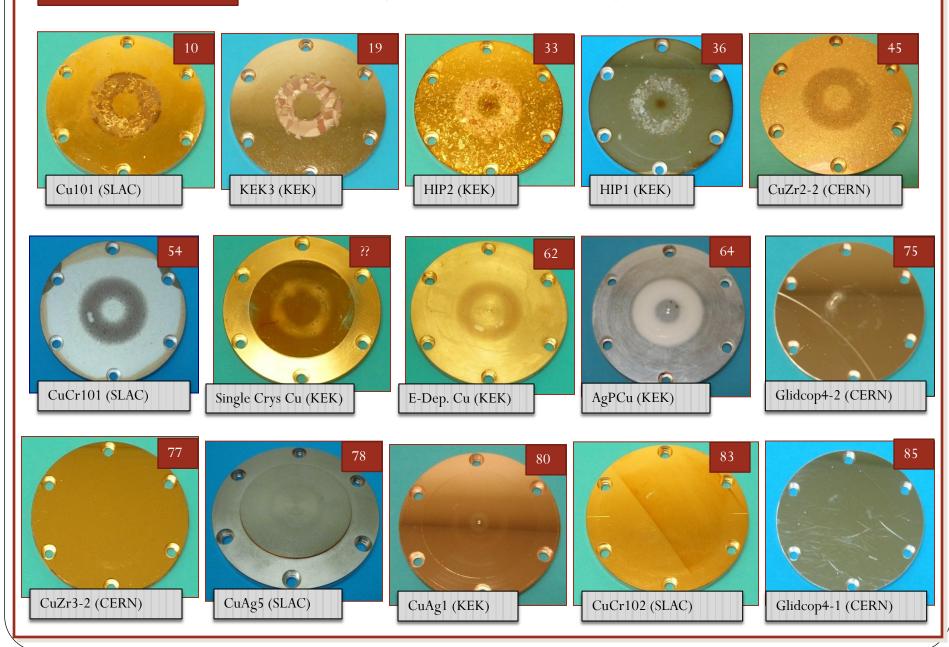




Hardness Test Value

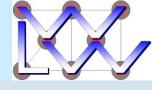
Lisa Laurent, SLAC

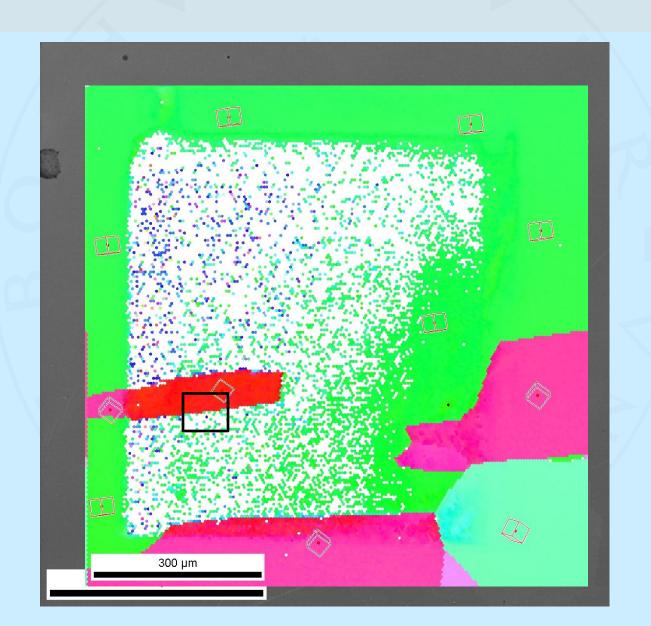
Pulse Heating Samples (CLIC09)

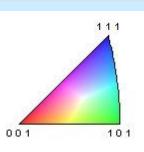


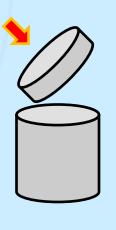


C10100_2h@1000_EP_45°Probe3_C1





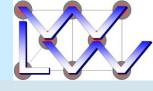


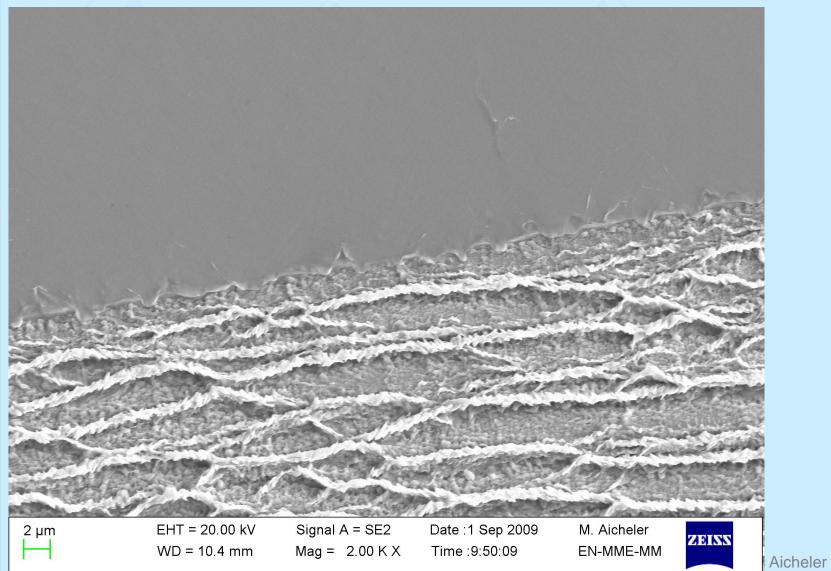


Markus Aicheler 15.10.2009



C10100_2h@1000_EP_45°Probe3_C1





CLIC09

15.10.2009